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20V N-Channel PowerTrench® MOSFET

General Description

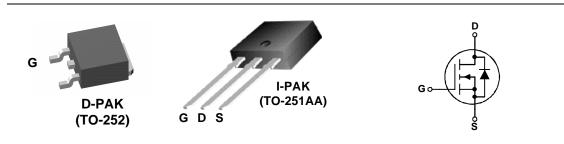
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$, fast switching speed and extremely low $R_{DS(ON)}$ in a small package.

Applications

- DC/DC converter
- Motor Drives

Features

- Low gate charge (16 nC)
- Fast Switching
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$



Absolute Maximum Ratings T_A=25°C unless otherwise noted

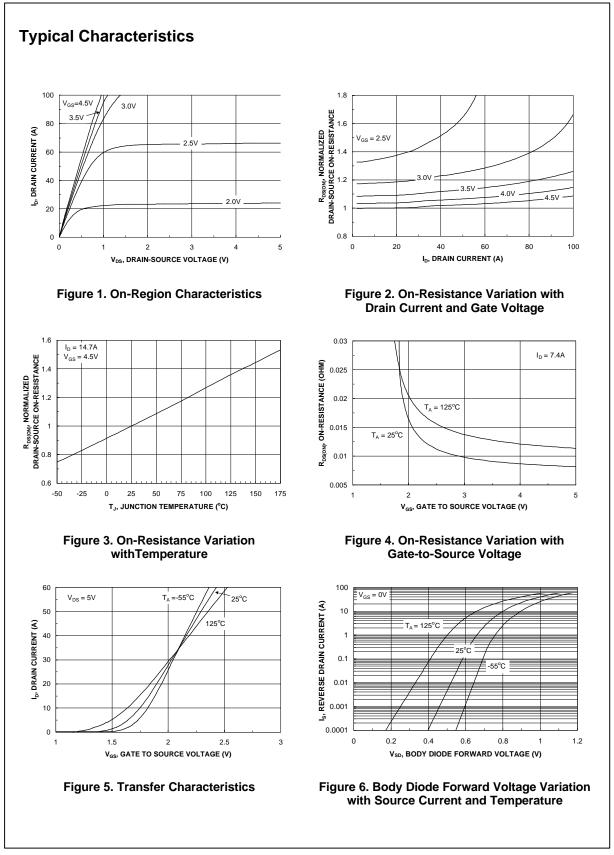
Symbol	Parameter							Units		
V _{DSS}	Drain-Sourc	e Voltage		20			V			
V _{GSS}	Gate-Source	e Voltage					± 12		V	
I _D	Continuous	Drain Current	@T _c =25°	С	(Note 3)		50		А	
			@T _A =25°	С	(Note 1a)		14.7			
			Pulsed		(Note 1a)		60			
P _D	Power Dissi	@T _c =25°	C=25°C (Note 3)		44			W		
			@T _A =25°	С	(Note 1a)		3.8			
			@T _A =25°	С	(Note 1b)		1.6			
T _J , T _{STG}	Operating and Storage Junction Temperature Range					-55 to +175			°C	
Therma	I Charac	teristics								
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)				(Note 1)	3.4			°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Am			bient	(Note 1a)	45			°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1b)				(Note 1b)	96			°C/W	
Packag	e Marking	g and Oro	dering	Infor	mation					
Device Marking		Device		Package		Reel Size	Reel Size Tape width		Quantity	
FDD3706		FDD3706		D-PAK (TO-252)		13"	16mm	16mm 250		
FDU3706		FDU3706		I-PAK (TO-251)		Tube	NI/A	N/A		

FDD3706/FDU3706

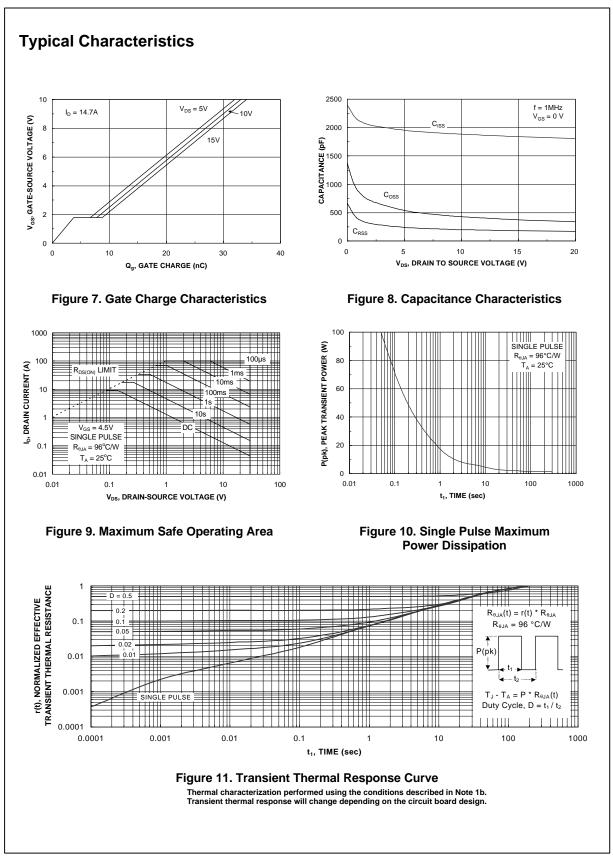
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March 2015

Alanche Ratings (Not rce Avalanche Energy rce Avalanche Current CS urce Breakdown Voltage n Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse CS (Note 2) shold Voltage	e 2) Single Pulse, $V_{DD} = 10V$, $I_D = 7A$ $V_{GS} = 0 V$, $I_D = 250 \mu A$ $I_D = 250 \mu A$, Referenced to $25^{\circ}C$ $V_{DS} = 16 V$, $V_{GS} = 0 V$ $V_{GS} = 12 V$, $V_{DS} = 0 V$ $V_{GS} = -12 V$ $V_{DS} = 0 V$	20	13	60 7 1 100	mJ A V mV/°C μA
rce Avalanche Energy rce Avalanche Current CS Irrce Breakdown Voltage n Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse CS (Note 2) shold Voltage	$\label{eq:VGS} \begin{array}{l} \mbox{Single Pulse, } V_{DD} = 10V, \ I_{D} = 7A \\ \\ \mbox{$V_{GS} = 0$ V, $I_{D} = 250$ μA} \\ \\ \mbox{$I_{D} = 250$ μA, Referenced to 25°C} \\ \\ \mbox{$V_{DS} = 16$ V, $V_{GS} = 0$ V} \\ \\ \mbox{$V_{GS} = 12$ V, $V_{DS} = 0$ V} \\ \end{array}$	20	13	7	Α V mV/°C μΑ
rce Avalanche Current S Trce Breakdown Voltage n Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse S (Note 2) shold Voltage	$\begin{split} V_{GS} &= 0 \ V, & I_D = 250 \ \mu A \\ I_D &= 250 \ \mu A, \text{Referenced to } 25^\circ\text{C} \\ V_{DS} &= 16 \ V, & V_{GS} = 0 \ V \\ V_{GS} &= 12 \ V, & V_{DS} = 0 \ V \end{split}$	20	13	1	A V mV/°C μA
irce Breakdown Voltage n Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse CS (Note 2) shold Voltage	$\begin{split} I_D &= 250 \; \mu \text{A}, \text{Referenced to } 25^\circ\text{C} \\ V_{DS} &= 16 \; \text{V}, \qquad V_{GS} &= 0 \; \text{V} \\ V_{GS} &= 12 \; \text{V}, \qquad V_{DS} &= 0 \; \text{V} \end{split}$	20	13		mV/°C μA
irce Breakdown Voltage n Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse CS (Note 2) shold Voltage	$\begin{split} I_D &= 250 \; \mu \text{A}, \text{Referenced to } 25^\circ\text{C} \\ V_{DS} &= 16 \; \text{V}, \qquad V_{GS} &= 0 \; \text{V} \\ V_{GS} &= 12 \; \text{V}, \qquad V_{DS} &= 0 \; \text{V} \end{split}$	20	13		mV/°C μA
n Voltage Temperature t Voltage Drain Current y Leakage, Forward y Leakage, Reverse CS (Note 2) shold Voltage	$\begin{split} I_D &= 250 \; \mu \text{A}, \text{Referenced to } 25^\circ\text{C} \\ V_{DS} &= 16 \; \text{V}, \qquad V_{GS} &= 0 \; \text{V} \\ V_{GS} &= 12 \; \text{V}, \qquad V_{DS} &= 0 \; \text{V} \end{split}$		13		μA
y Leakage, Forward y Leakage, Reverse CS (Note 2) shold Voltage	$V_{GS} = 12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$				•
y Leakage, Reverse CS (Note 2) shold Voltage				100	
CS (Note 2) shold Voltage	$V_{GS} = -12 \text{ V} \qquad V_{DS} = 0 \text{ V}$			100	nA
shold Voltage	·			-100	nA
shold Voltage					
•	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.5	1	1.5	V
shold Voltage ure Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$	-	-3.5	-	mV/°C
n–Source tance	$ \begin{array}{ll} V_{GS} = 10 \; V, & I_D = 16.2 \; A \\ V_{GS} = 4.5 \; V, & I_D = 14.7 \; A \\ V_{GS} = 2.5 \; V, & I_D = 12.2 \; A \\ V_{GS} = 4.5 \; V, \; I_D = 14.7 \; A, T_J = 125^\circ C \end{array} $		7.5 8 11 12.6	9 11 16 19	mΩ
Drain Current	$V_{GS} = 4.5 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	30			А
ransconductance	$V_{DS} = 5 V$, $I_D = 14.7 A$		65		S
eristics					
			1882		pF
pacitance			430		pF
ransfer Capacitance	t = 1.0 MHZ		201		pF
cteristics (Note 2)					
			11	20	ns
Rise Time	$V_{DD} = 10 V, \qquad I_D = 1 A,$		15	27	ns
Delay Time	$V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		35	56	ns
Fall Time			16	29	ns
Charge			16	23	nC
rce Charge			3.7		nC
n Charge			4		nC
ode Characteristics	and Maximum Ratings				
				3.2	Α
rce Diode Forward Volta	ge $V_{GS} = 0 V$, $I_S = 3.2 A$ (Note 2)		0.7	1.2	V
	Drain Current ransconductance teristics acitance pacitance ransfer Capacitance Cteristics (Note 2) Delay Time Rise Time Delay Time Fall Time a Charge in Charge in Charge Continuous Drain–Sourcure urce Diode Forward Voltage -to-case and case-to-ambient ther	$V_{GS} = 2.5 \text{ V}, I_D = 12.2 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 14.7 \text{ A}, \text{T}_J = 125^{\circ}\text{C}$ Drain Current $V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$ Transconductance $V_{DS} = 5 \text{ V}, I_D = 14.7 \text{ A}$ teristics acitance $V_{DS} = 5 \text{ V}, I_D = 14.7 \text{ A}$ teristics acitance $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$ Transfer Capacitance $Cteristics (Note 2)$ Delay Time Rise Time $V_{DS} = 10 \text{ V}, I_D = 1 \text{ A}, V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$ Fall Time $V_{DS} = 10 \text{ V}, I_D = 14.7 \text{ A}, V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$ Fall Time $V_{DS} = 10 \text{ V}, I_D = 14.7 \text{ A}, V_{GS} = 4.5 \text{ V}$ in Charge $V_{DS} = 10 \text{ V}, I_D = 14.7 \text{ A}, V_{GS} = 4.5 \text{ V}$ The second se	VGS = 2.5 V, ID = 12.2 A VGS = 4.5 V, ID = 14.7 A, TJ = 125°CDrain CurrentVGS = 4.5 V, VDS = 5 V30TransconductanceVDS = 5 V, ID = 14.7 A30teristicsacitance pacitanceVDS = 10 V, VGS = 0 V, f = 1.0 MHz10 = 14.7 Ateristics (Note 2)VDS = 10 V, VGS = 0 V, f = 1.0 MHzID = 1 A, VDD = 10 V, ID = 14.7 A, VDS = 4.5 V, VGS = 4.	VGS = 2.5 V, ID = 12.2 A VGS = 4.5 V, ID = 14.7 A, TJ = 125°C11 12.6Drain CurrentVGS = 4.5 V, VDS = 5 V30TransconductanceVDS = 5 V, ID = 14.7 A65teristicsacitanceVDS = 10 V, VGS = 0 V, ID = 14.7 Atransfer CapacitanceVDS = 10 V, VGS = 0 V, IS = 1.0 MHZ1882teristics (Note 2)Delay TimeVDD = 10 V, ID = 1 A, VDD = 10 V, ID = 1 A, VGS = 4.5 V, RGEN = 6 \OmegaTotal Note 2)Delay TimeVDD = 10 V, ID = 1 A, VGS = 4.5 V, RGEN = 6 \OmegaTotal Note 2)Delay TimeVDD = 10 V, ID = 1 A, VGS = 4.5 V, RGEN = 6 \OmegaTotal Note 2)Delay TimeVDS = 10V, VDS = 10V, ID = 14.7 A, TJ = 125°CTotal Note 2)Delay TimeVDS = 10V, VDS = 10V, VDS = 10V, VGS = 4.5 VTotal Note 2)Total Note 2)Delay TimeVDS = 10V, VDS = 10V, VGS = 4.5 VTotal Note 2)Total National RatingsContinuous Drain–Source Diode Forward CurrentTotal National RatingsContinuous Drain–Source Diode Forward CurrentTotal A (Note 2)O, Tase and case-to-ambient thermal resistance where the case thermal reference is defined as the sold	VGS = 2.5 V, ID = 12.2 A1116VGS = 4.5 V, ID = 14.7 A, TJ = 125°C1116Drain CurrentVGS = 4.5 V, VDS = 5 V30TransconductanceVDS = 5 V, ID = 14.7 A65teristicsacitanceupacitanceVDS = 10 V, VGS = 0 V, f = 1.0 MHzTransfer Capacitancef = 1.0 MHzCteristics (Note 2)201Delay TimeVDD = 10 V, ID = 1 A, VGS = 6 DRise TimeVGS = 4.5 V, RGEN = 6 DDelay Time16Fall Time16OchargeVDS = 10V, VGS = 0 V, ID = 14.7 A, VGS = 4.5 VObe ChargeVDS = 10V, ID = 14.7 A, VGS = 4.5 VVDS = 4.5 V, RGEN = 6 D35Sofe ChargeVGS = 4.5 VVDS = 10V, VGS = 0 V, ID = 14.7 A, VGS = 4.5 VUD = 10V, VGS = 0 V, ID = 14.7 A, VGS = 4.5 VUD = 10V, VGS = 0 V, ID = 14.7 A, VGS = 4.5 VUD = 10V, VGS = 0 V, ID = 14.7 A, VGS = 4.5 VUD = 10V, VGS = 0 V, IS = 3.2 A (Note 2)Ote Characteristics and Maximum RatingsContinuous Drain-Source Diode Forward Current3.2urce Diode Forward VoltageVGS = 0 V, IS = 3.2 A (Note 2)-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting



FDD3706/FDU3706 Rev. 1.3



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